

## [Bibliography]

[Document Name] Amendment to specification  
[Receiver] Commissioner  
[Filing Date] 06 December 2002

[Applicant] Integrated Process Systems  
[Name] 1-1998-097346-8  
[Applicant code] Applicant  
[Relationship to the case]

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Registration No.]

[Indication of the case]  
[Application No.] 10-2002-0072380  
[Application Date] 20 November 2002  
[Date of Request for Examination] 20 November 2002  
[Title] Method for depositing thin film on wafer using Aluminum compound

[Reason for submission]  
[Receipt Number] 1-1-02-0383122-50  
[Receipt Data] 20 November 2002  
[Document to be amended] Specification

[Items to be amended]  
[Item subject to amendment] as attached  
[Amendment method] as attached  
[Contact of amendment] as attached

[Purpose] We file as above according to Art. 13 of the Patent Law Enforcement rule, and according to Art. 8 of the Utility Model Law Enforcement rule.  
Attorney Youngpil Lee

[Fee]  
[Amendment fee] 0 won  
[Additional Examination fee] 0 won  
[Other fees ] 0 won  
[Total] 0 won

[Enclosures]  
1. Document certifying content of amendment 1 copy each